

Product data sheet

1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a leadless ultra small DFN1608D-2 (SOD1608) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 2 A
- Reverse voltage: V_R ≤ 40 V
- Low forward voltage V_F ≤ 660 mV
- Low reverse current
- AEC-Q101 qualified
- Solderable side pads
- Package height typ. 0.37 mm
- Ultra small and leadless SMD plastic package

3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- LED backlight for mobile application
- Low power consumption applications
- Ultra high-speed switching
- Reverse polarity protection

4. Quick reference data

Table 1. Qui	ck reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)} average forward current		δ = 0.5; f = 20 kHz; T _{sp} ≤ 130 °C; square wave		-	-	2	A
		δ = 0.5; f = 20 kHz; T _{amb} ≤ 25 °C; square wave	[1]	-	-	2	A
V _R	reverse voltage	T _j = 25 °C		-	-	40	V
V _F	forward voltage	I _F = 2 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C		-	585	660	mV





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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
I _R	reverse current	V _R = 10 V; T _j = 25 °C	-	1	5	μA
t _{rr}	reverse recovery time	$I_R = 0.5 \text{ A}; I_F = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$	-	4	-	ns

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.

5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	к	cathode[1]		1 🛃 2
2	A	anode		sym001
			Transparent top view DFN1608D-2 (SOD1608)	

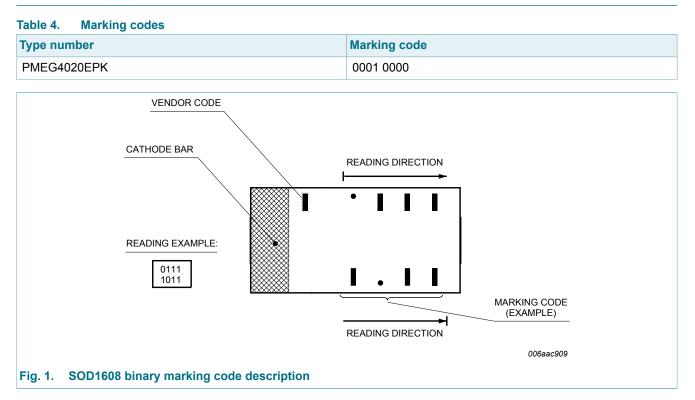
[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PMEG4020EPK	DFN1608D-2	DFN1608D-2: leadless ultra small plastic package; 2 terminals	SOD1608			

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7. Marking



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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _R	reverse voltage	T _j = 25 °C		-	40	V
I _F	forward current	T _{sp} ≤ 125 °C		-	2.83	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; T _{sp} ≤ 130 °C; square wave		-	2	A
		δ = 0.5; f = 20 kHz; T _{amb} ≤ 25 °C; square wave	[1]	-	2	A
I _{FRM}	repetitive peak forward current	$t_p \le 1 \text{ ms}; \delta \le 0.25$		-	4	А
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	5	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	415	mW
			[3]	-	895	mW
			[1]	-	1565	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)} thermal resistance from junction to ambient		in free air	[1][2]	-	-	300	K/W
		[1][3]	-	-	140	K/W	
	ambient		[1][4]	-	-	80	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[5]	-	-	20	K/W

 For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

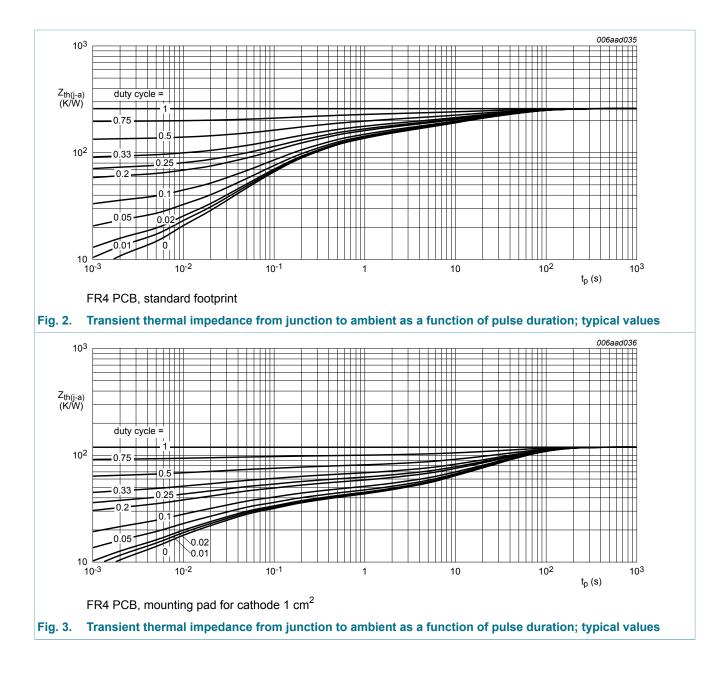
^[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

[5] Soldering point of cathode tab.

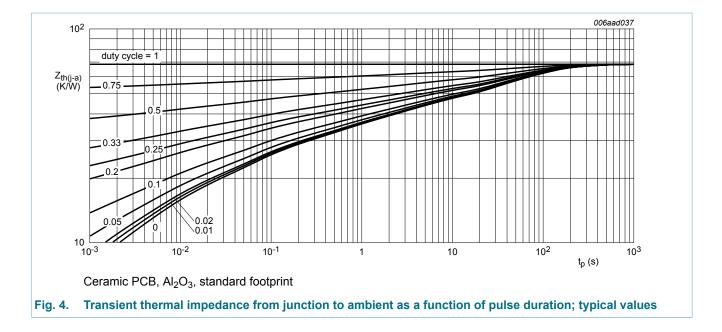
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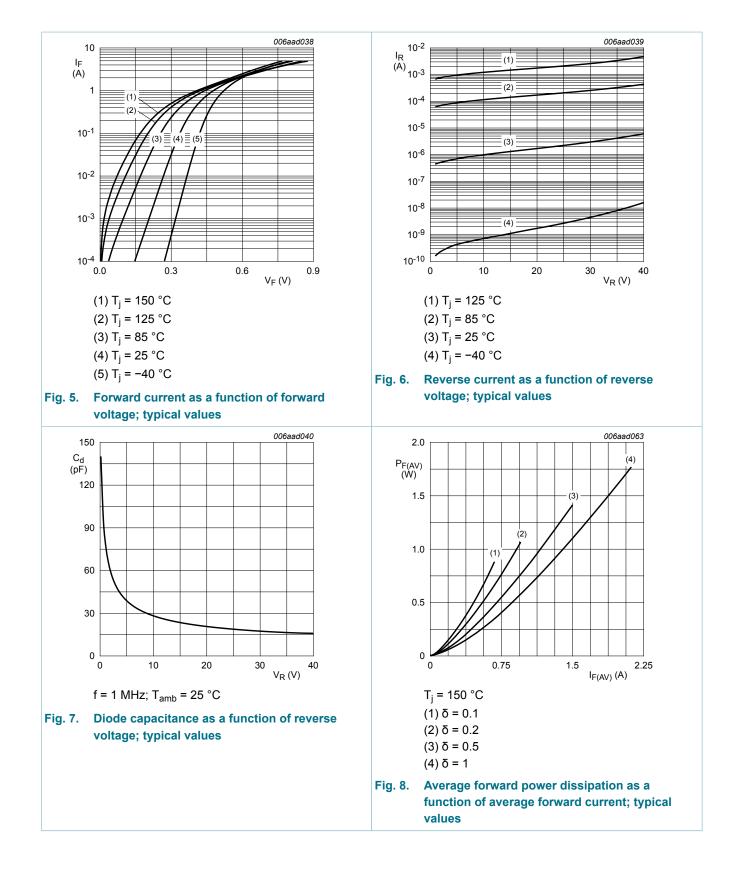


10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F forward voltage	forward voltage	I_F = 100 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	330	380	mV
	I _F = 500 mA; pulsed; t _p ≤ 300 μs; $\delta \le 0.02$; T _j = 25 °C	-	415	480	mV	
	I _F = 1 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	490	550	mV	
	I _F = 2 A; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _j = 25 °C	-	585	660	mV	
I _R reverse current	reverse current	V _R = 10 V; T _j = 25 °C	-	1	5	μA
		V _R = 40 V; T _j = 25 °C	-	8	30	μA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	75	90	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	30	40	pF
t _{rr}	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$	-	4	-	ns
V _{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A}/\mu\text{s}; T_j = 25 ^\circ\text{C}$	-	440	-	mV

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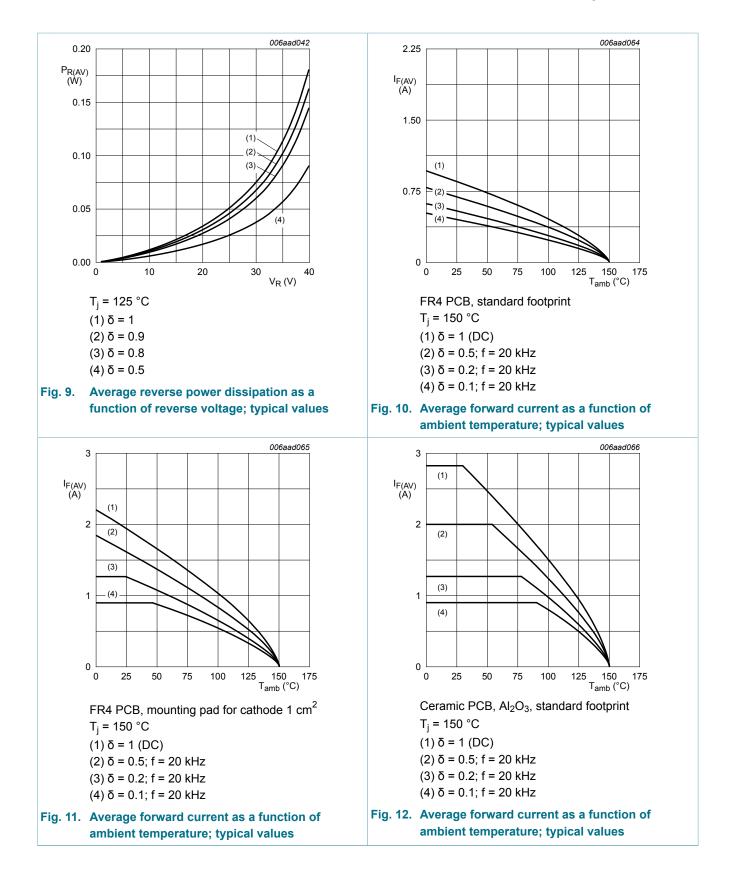


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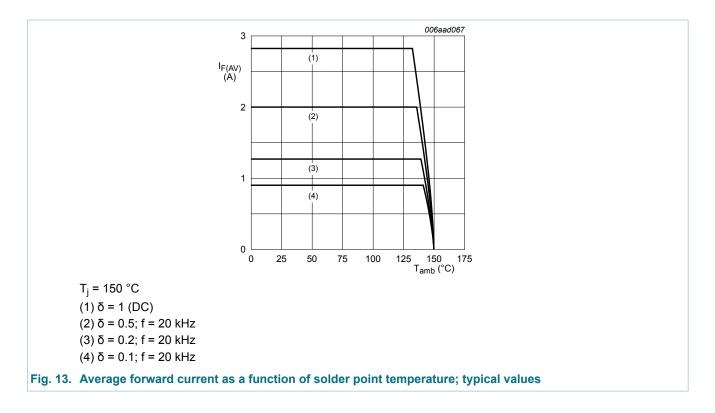
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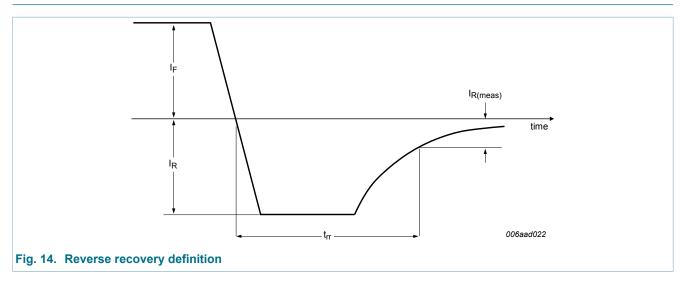


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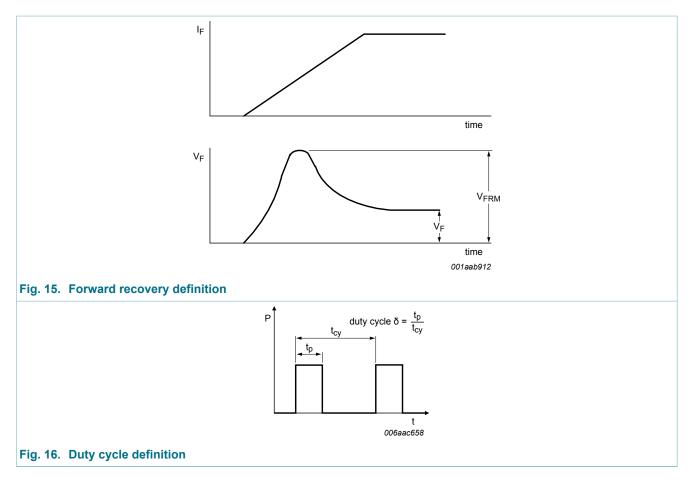


11. Test information



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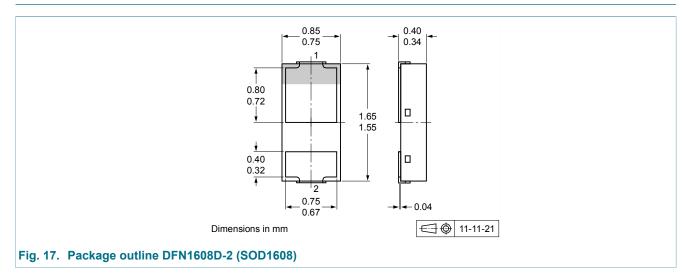
The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

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12. Package outline



13. Soldering

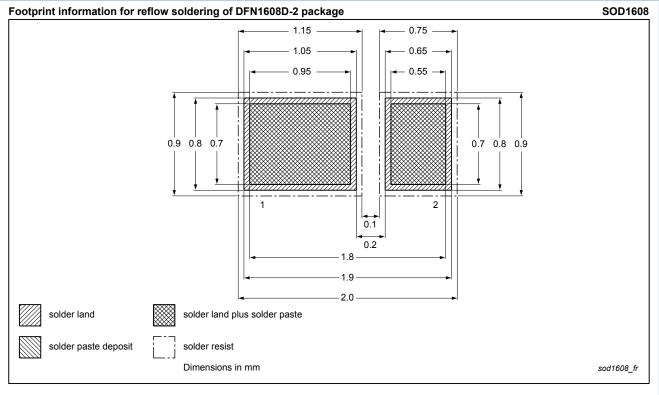


Fig. 18. Reflow soldering footprint for DFN1608D-2 (SOD1608)

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14. Revision history

Table 8. Revision hi	story			
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG4020EPK v.2	20140211	Product data sheet	-	PMEG4020EPK v.1
Modifications:	Marking code corre	cted	·	
PMEG4020EPK v.1	20120425	Product data sheet	-	-

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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